



# Practical Application of the IEEE P370 standard draft for measurement of interconnects up to 50 GHz

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## Outline

- Background
- Best Practices
  - Test Fixture Design
  - PCB Design
- De-embedding methods
- S-parameter Quality Tools and Metrics
- Comparison of S-parameters
- De-embedding Verification
  - Using the S-parameter library
  - Using the Plug and Play fixtures
  - Using test board measurements
- References



## Background

- Increased accuracy needed for simulation of systems using devices operating with significant spectral content at 50 GHz; e. g., 56 Gb/s
- Accurate de-embedding method needed for devices characterized to 50 GHz
- Different structures, different methods in use in industry
  - Lack of consistency
  - Proprietary algorithms, tools
  - Poor results due to poor fixture design
  - Poor quality S-parameter data -> inaccurate simulation
  - No objective way to evaluate quality of results
- P370 is not a calibration standard (see P378, now expired)

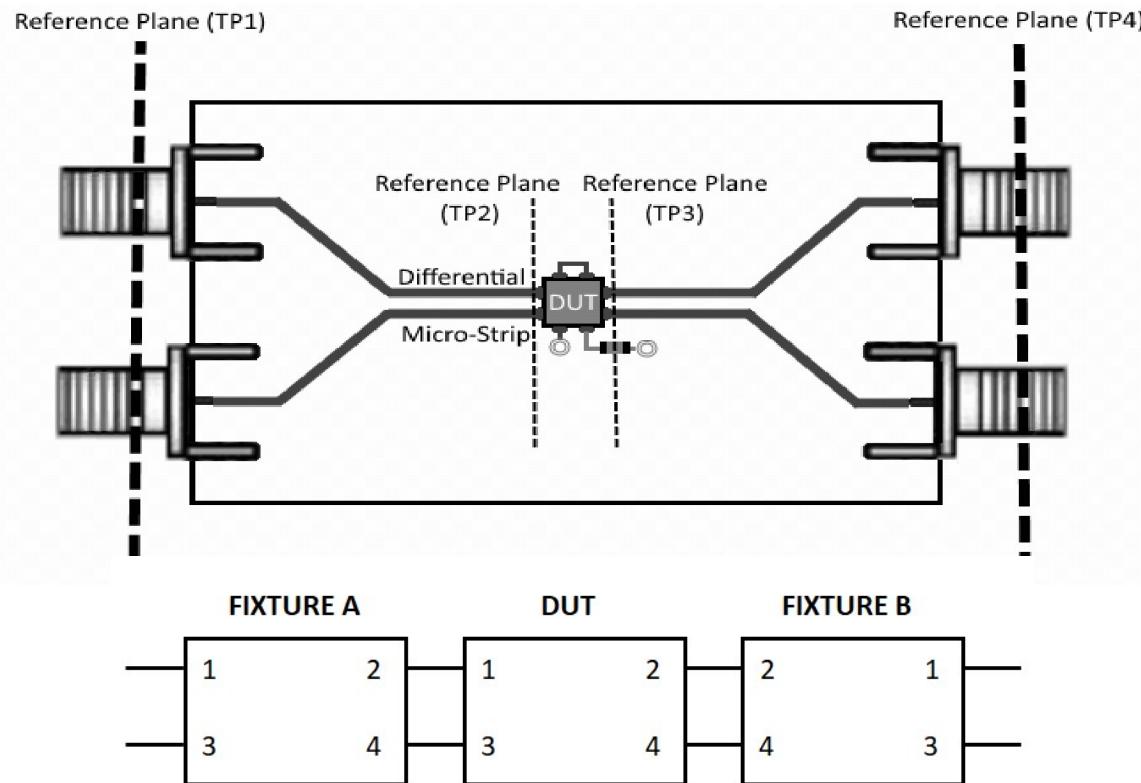


## Best Practices – guidance on

- Test Fixture Design
  - Limits defined for insertion loss, return loss, crosstalk, crosstalk-IL difference, impedance, common mode conversion, skew
- Measurement equipment, test cables and connectors
- PCB Design
  - Launch connectors and footprints
  - Conductor geometry, plating, surface roughness
  - Dielectric material
  - Stitching vias, Ground plane cutouts, return paths

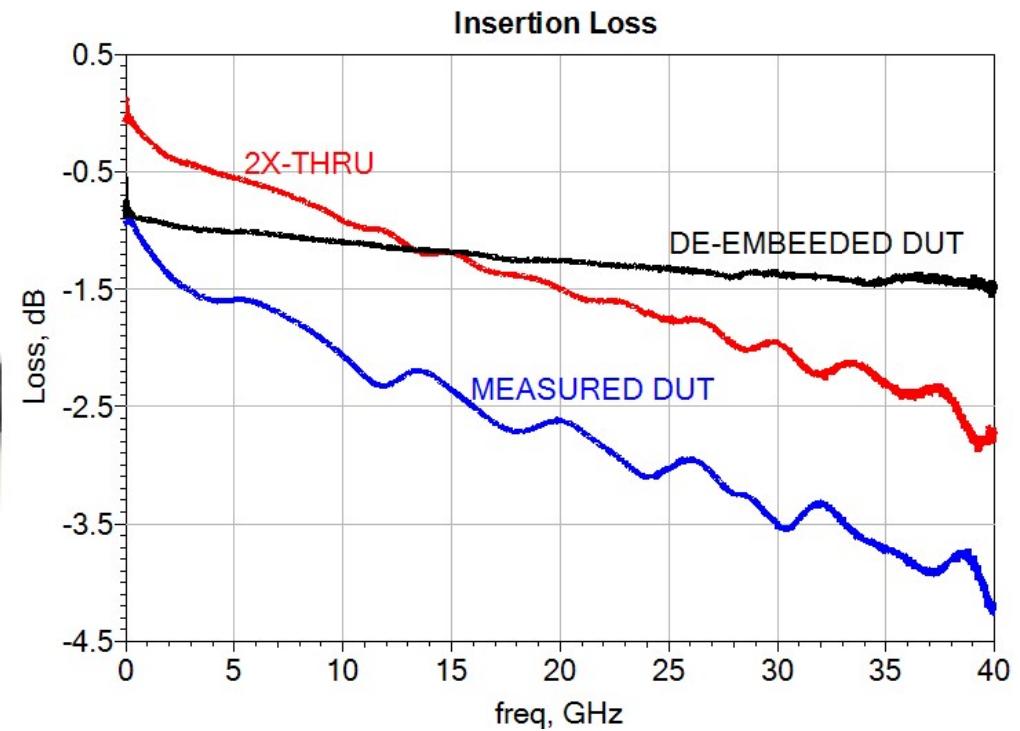
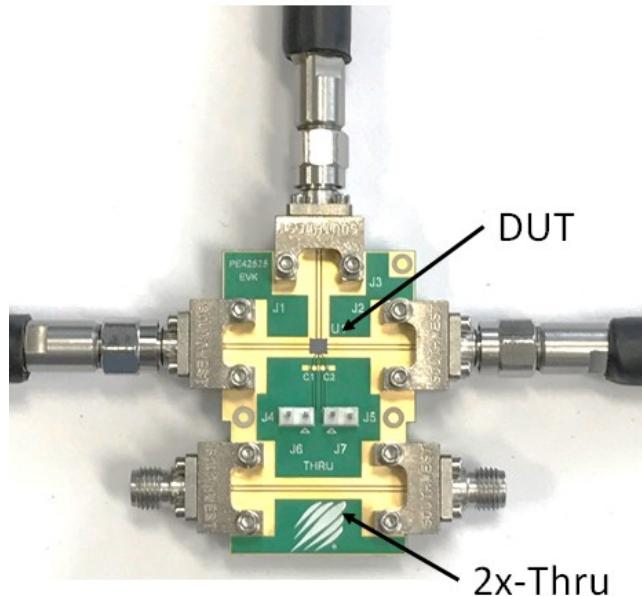


De-embedding objective: Separate the DUT from the fixture





De-embedding objective: Separate the DUT from the fixture





## De-embedding methods

- 1x Reflect – uses single Open or Short standard
- 2x thru – uses measured 2x thru
- 2x Impedance-corrected thru – uses 2x thru
  - Compensates for Z mismatch between 2x-thru and FIX-DUT-FIX, reduces causality errors
- Tool developers: Evaluate the accuracy of the method (code)
- Tool users: Evaluate the quality/accuracy of the results



## S-parameter Quality Tools and Metrics

- Tools developed for evaluating quality of S-parameters
  - Causality
  - Passivity
  - Reciprocity
- Metrics (limits) defined
- Tool developed for quantifying difference between two S-parameters



## De-embedding Verification

- Using the S-parameter library
  1. Build network using desired library elements
  2. Simulate network
  3. De-embed the DUT
  4. Compare de-embedded simulated DUT results with library data for DUT



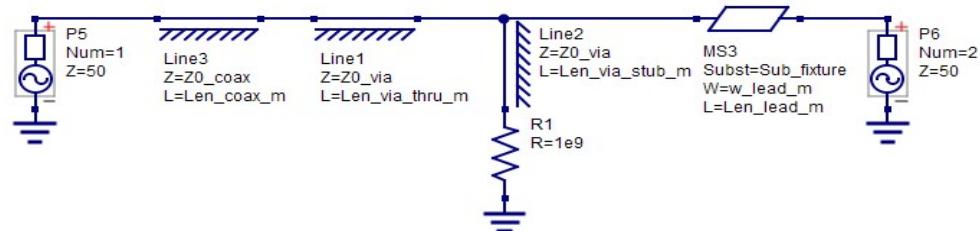
## De-embedding Verification

- S-parameter library example:  
Line structure

### S parameter simulation

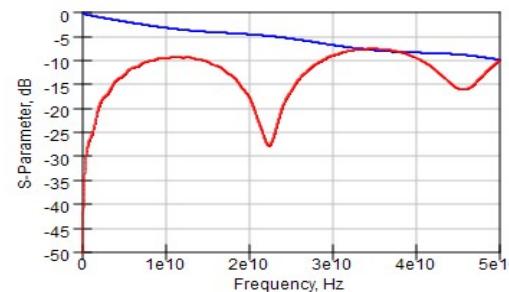
SP1  
Type=lin  
Start=20 MHz  
Stop=50 GHz  
Points=2500

#### FixtureL



#### |Equation

coax\_feed  
Z0\_coax=50  
Len\_coax\_mm=5  
Dk\_coax=2.2



#### |Equation

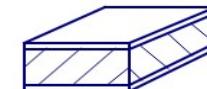
via  
Z0\_via=35  
Len\_via\_thru\_mm=3  
Dk\_via=3.8

#### |Equation

viaStub  
Len\_via\_stub\_mm=0.25

#### |Equation

Eqn7  
Len\_lead\_mm=25  
w\_lead\_mm=0.15  
Dk\_lead=3.8  
Df\_lead=0.02  
MS\_aspectRatio\_w\_h=2

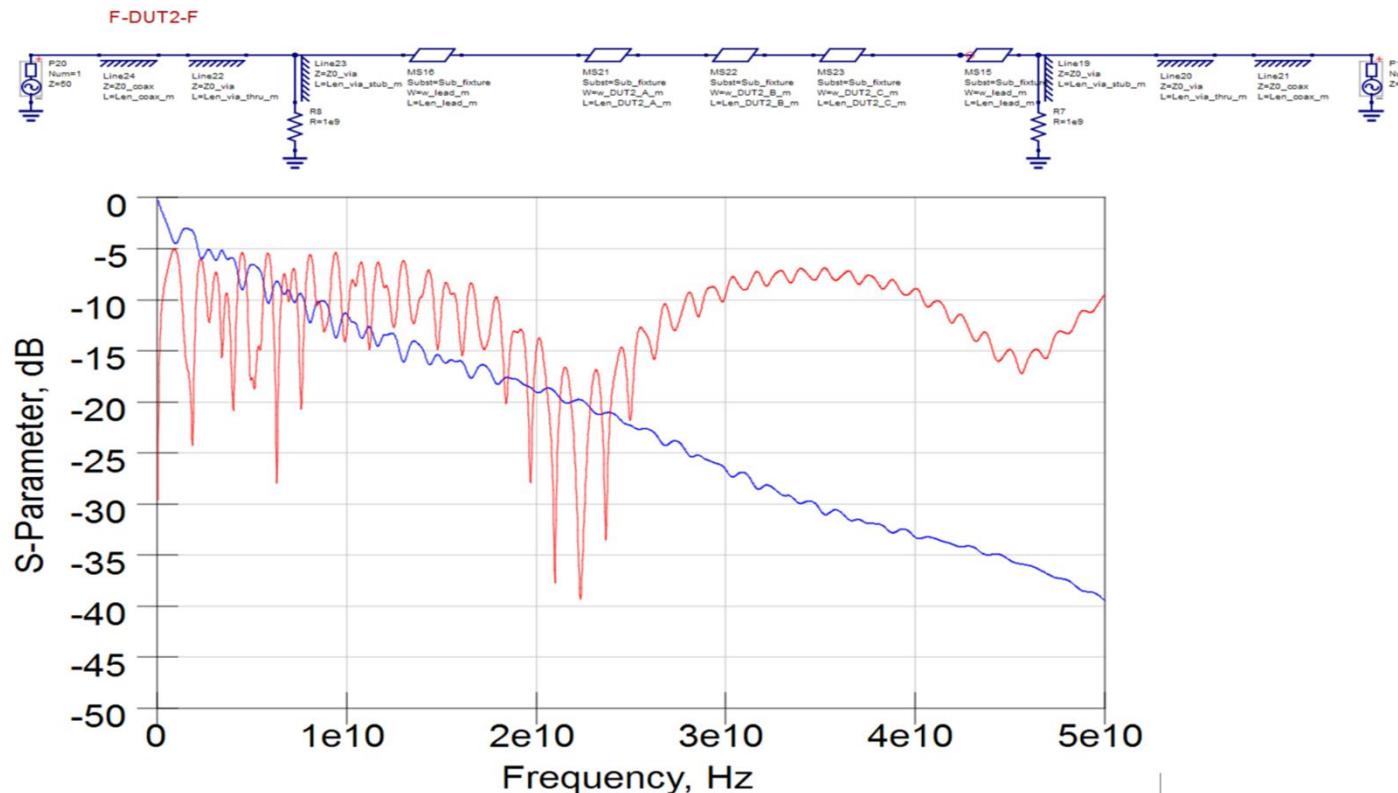


Sub\_fixture  
er=Dk\_lead  
h=h\_lead\_m  
t=17 um  
tand=Df\_lead  
rho=0.022e-6  
D=0



## De-embedding Verification

- S-parameter library example:  
**FIX-DUT-FIX**





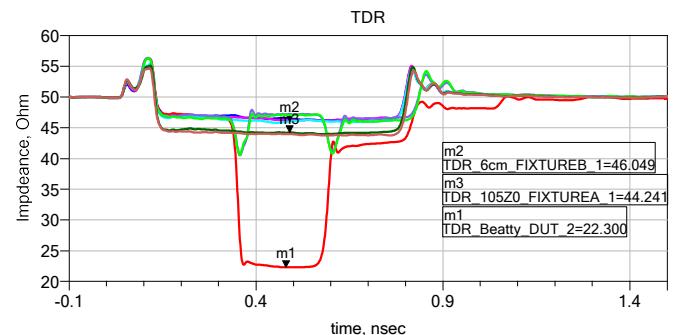
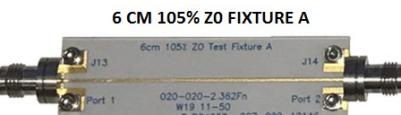
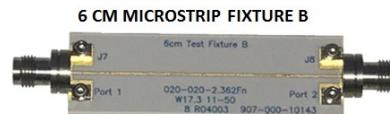
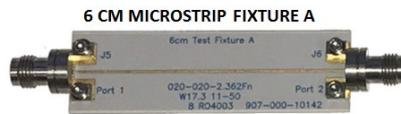
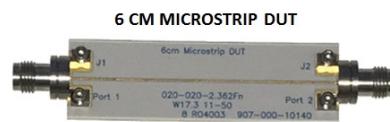
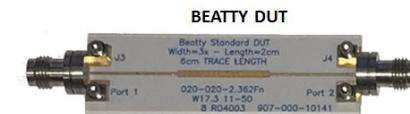
## De-embedding Verification

- Using the Plug and Play Fixtures
  1. Build network using desired Plug and Play components
  2. Measure network
  3. De-embed the DUT
  4. Compare de-embedded measured DUT results with Plug and Play data for DUT



## De-embedding Verification

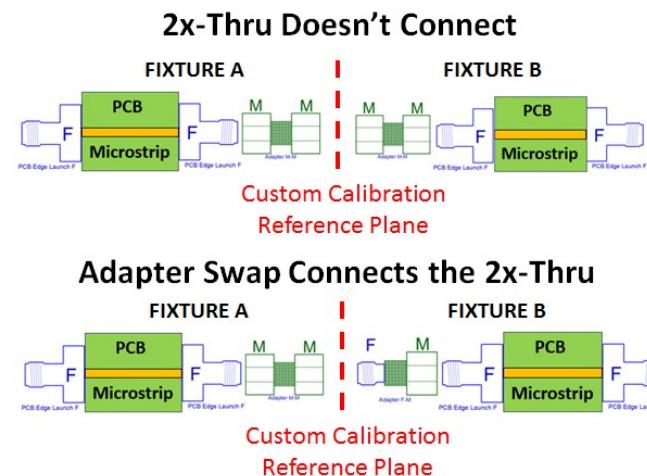
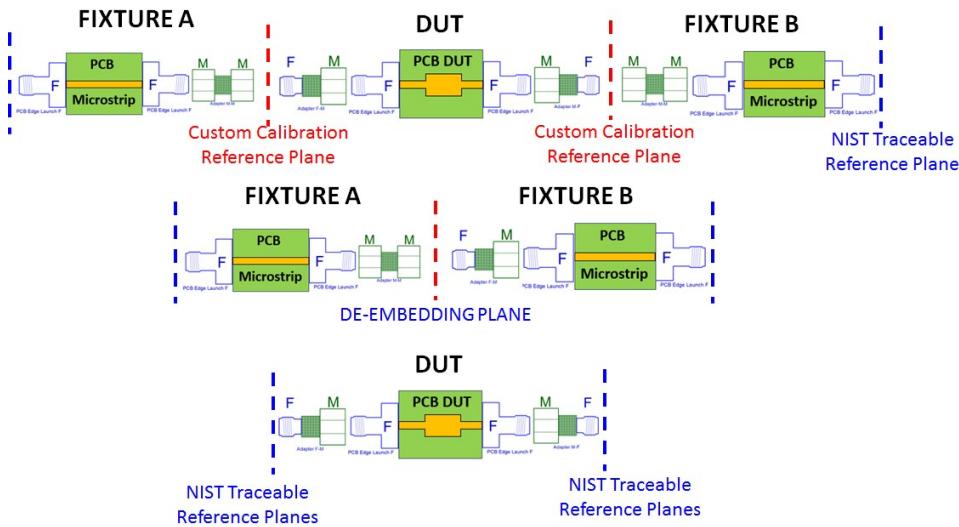
- Using the Plug and Play Fixtures





## De-embedding Verification

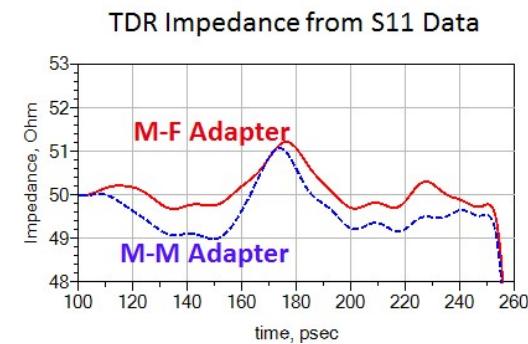
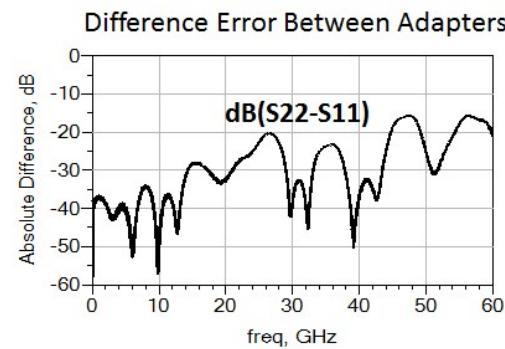
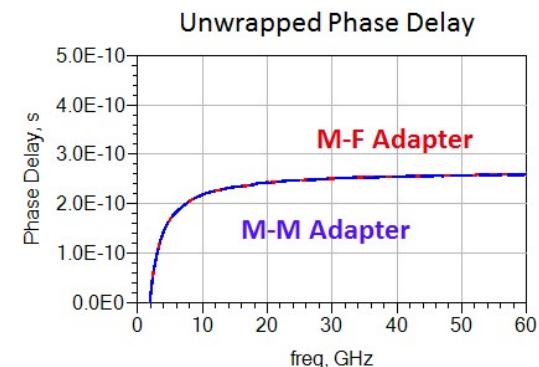
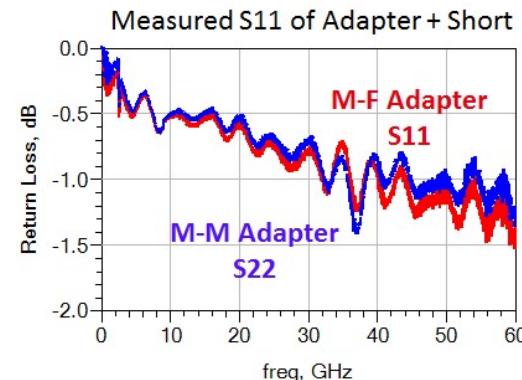
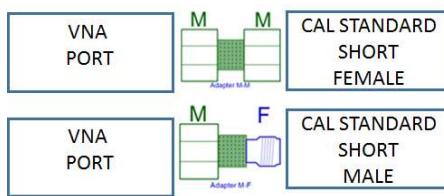
- Using the Plug and Play Fixtures





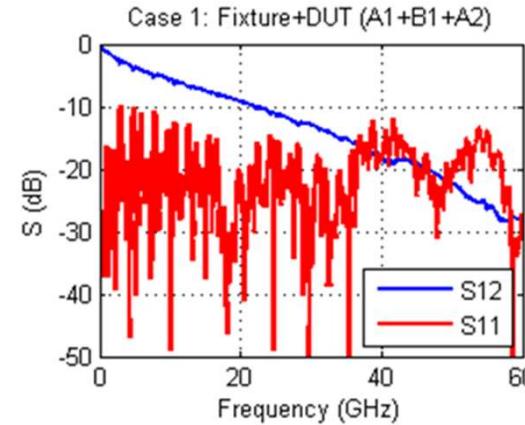
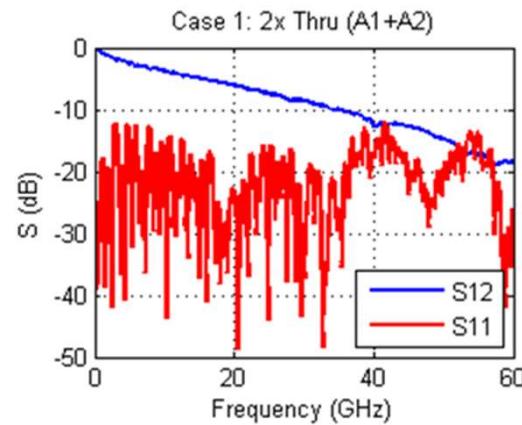
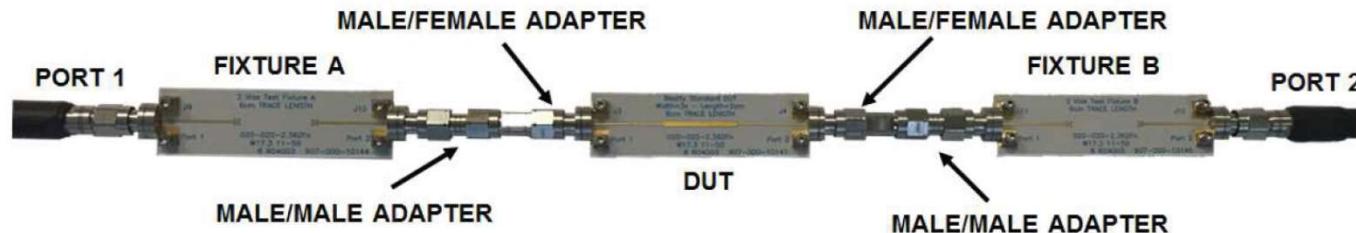
## De-embedding Verification

- Plug and Play Fixture adapter swap procedure



## De-embedding Verification

- Plug and Play Fixture example: 50 Ohm microstrip, 50 Ohm fixture





## De-embedding Verification

- Plug and Play Fixture example: 50 Ohm microstrip, 50 Ohm fixture, cont'd

A screenshot of a software application window titled "IEEE\_P370\_Sparam\_Quality\_rev0p5". The main title bar says "IEEE P370 S-param Quality rev0.5". Below the title, there is a list of three s-parameter files: "D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case1\_DUT\_Dmbd1\_S2\_M16.s2p", "D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case5\_DUT\_Dmbd1\_S2\_M16.s2p", and "D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case5\_DUT\_Dmbd2\_S2\_M16.s2p". To the right of this list are "Add" and "Delete" buttons. At the bottom of the list area is a vertical scroll bar. Below the list, there are two sections: "Time Domain Setting" and "SQM in FD".

**Time Domain Setting**

Data Rate [Gbps]	20
Rise Time [psec]	20
Sample per UI	32
internal setting	
Pulse Shape (1:Gaussian, 2:Butterworth filter)	1

**SQM in FD**

Passivity Quality in FD	[checkbox]
Causality Quality in FD	[checkbox]
Reciprocity Quality in FD	[checkbox]

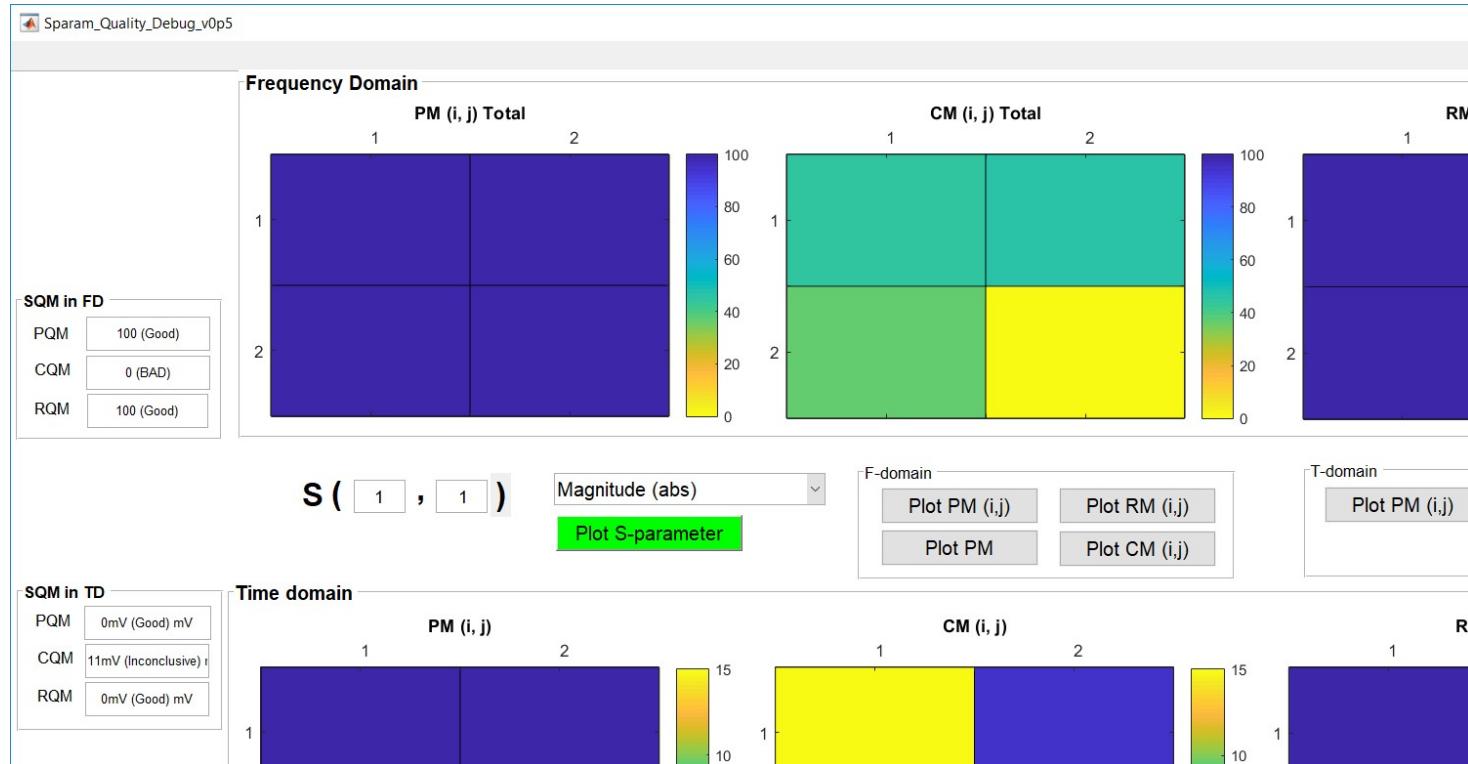
**SQM in TD**

Passivity Quality in TD	[checkbox]
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## De-embedding Verification

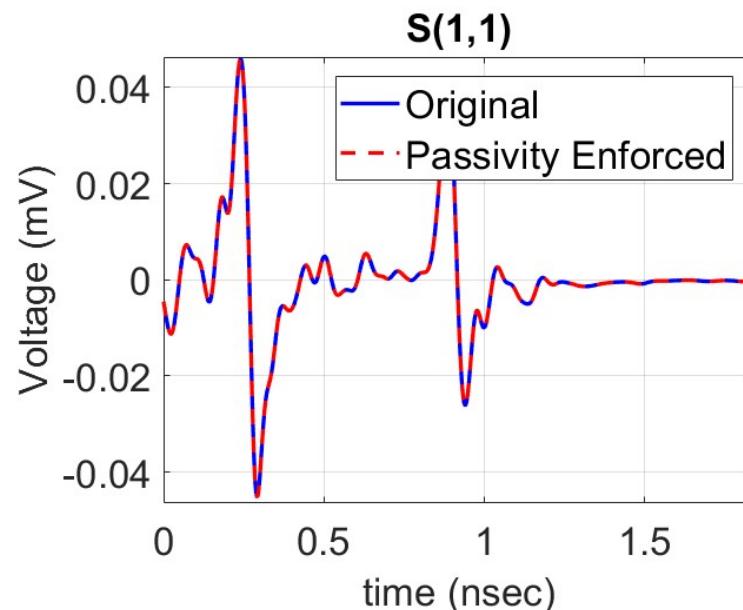
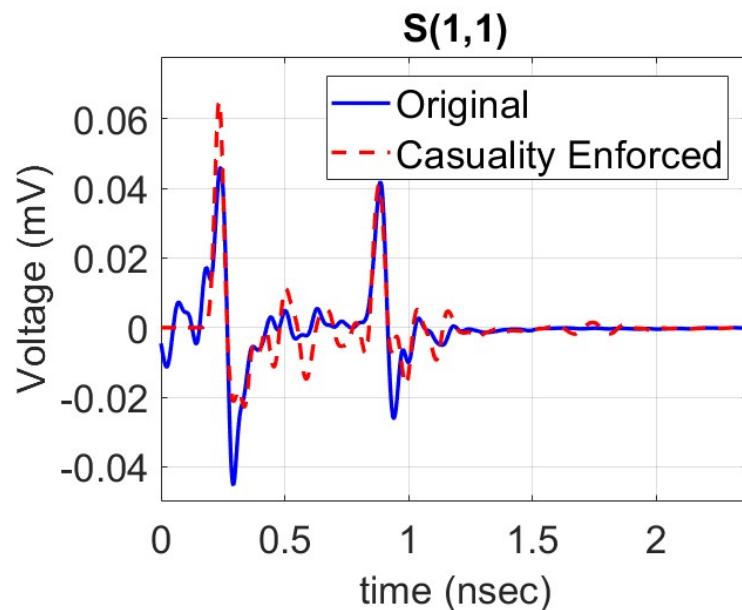
- Plug and Play Fixture example: 50 Ohm microstrip, 50 Ohm fixture, cont'd





## De-embedding Verification

- Plug and Play Fixture example: 50 Ohm microstrip, 50 Ohm fixture, cont'd





## De-embedding Verification

- Plug and Play Fixture example: 50 Ohm microstrip, 45 Ohm fixture, Z-corr.

IEEE\_P370\_Sparam\_Quality\_rev0p5

### IEEE P370 S-param Quality rev0.5

D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case1\_DUT\_Dmbd1\_S2\_M16.s2p  
D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case5\_DUT\_Dmbd1\_S2\_M16.s2p  
D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case5\_DUT\_Dmbd2\_S2\_M16.s2p

Add  
Delete

Time Domain Setting

Data Rate [Gbps]	20
Rise Time [psec]	20
Sample per UI	32

internal setting

Pulse Shape (1:Gaussian, 2:Butterworth filter)	1
---	---

SQM in FD

Passivity Quality in FD	9!
Causality Quality in FD	
Reciprocity Quality in FD	

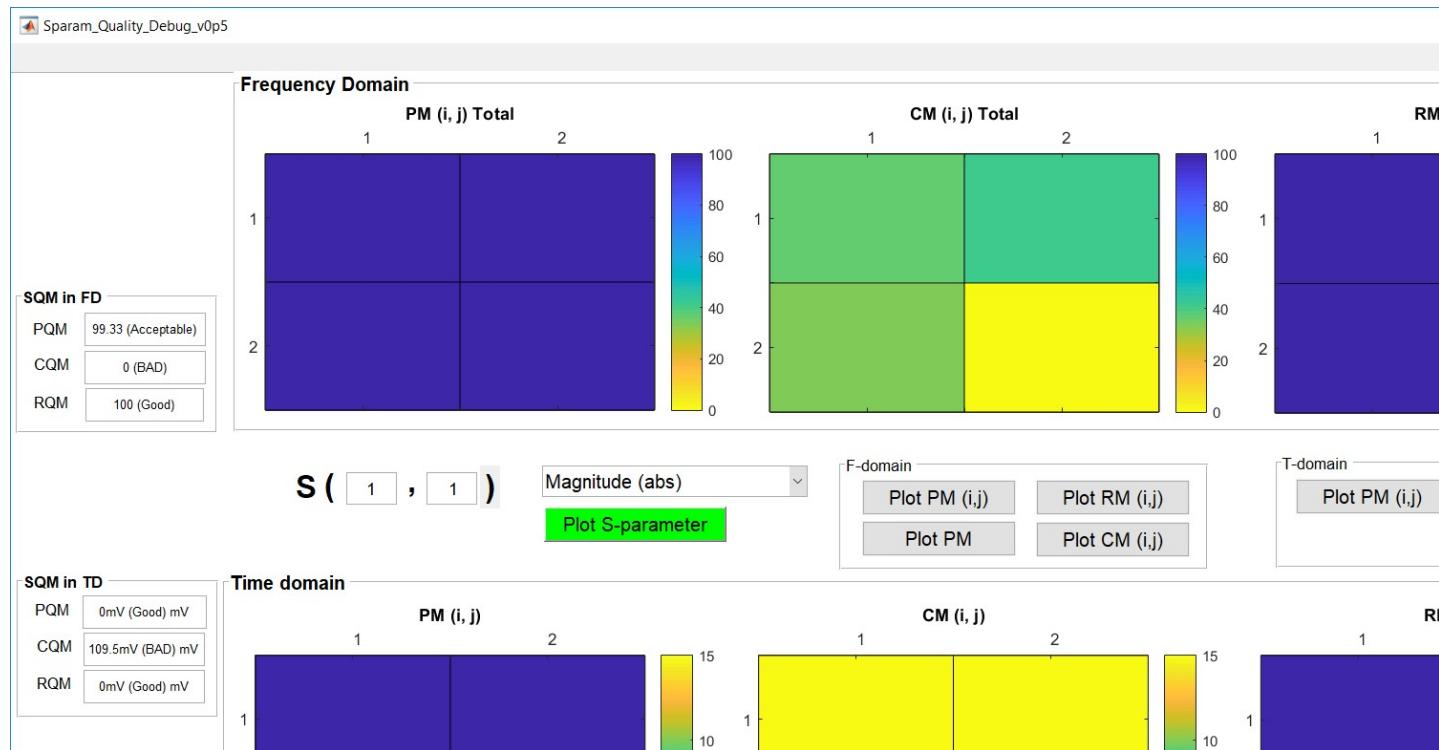
SQM in TD

Passivity Quality in TD	
-------------------------	--



## De-embedding Verification

- Plug and Play Fixture example: 50 Ohm microstrip, 45 Ohm fixture, uncorr.





## De-embedding Verification

- Plug and Play Fixture example: 50 Ohm microstrip, 45 Ohm fixture, uncorr.

IEEE\_P370\_Sparam\_Quality\_rev0p5

### IEEE P370 S-param Quality rev0.5

D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case1\_DUT\_Dmbd1\_S2\_M16.s2p  
D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case5\_DUT\_Dmbd1\_S2\_M16.s2p  
D:\Users\jdiep\Documents\EE stuff\Tools\AtaiTec\data\Case5\_DUT\_Dmbd2\_S2\_M16.s2p

Add  
Delete

Time Domain Setting

Data Rate [Gbps]	20
Rise Time [psec]	20
Sample per UI	32
internal setting	
Pulse Shape (1:Gaussian, 2:Butterworth filter)	1

SQM in FD

- Passivity Quality in FD
- Causality Quality in FD
- Reciprocity Quality in FD

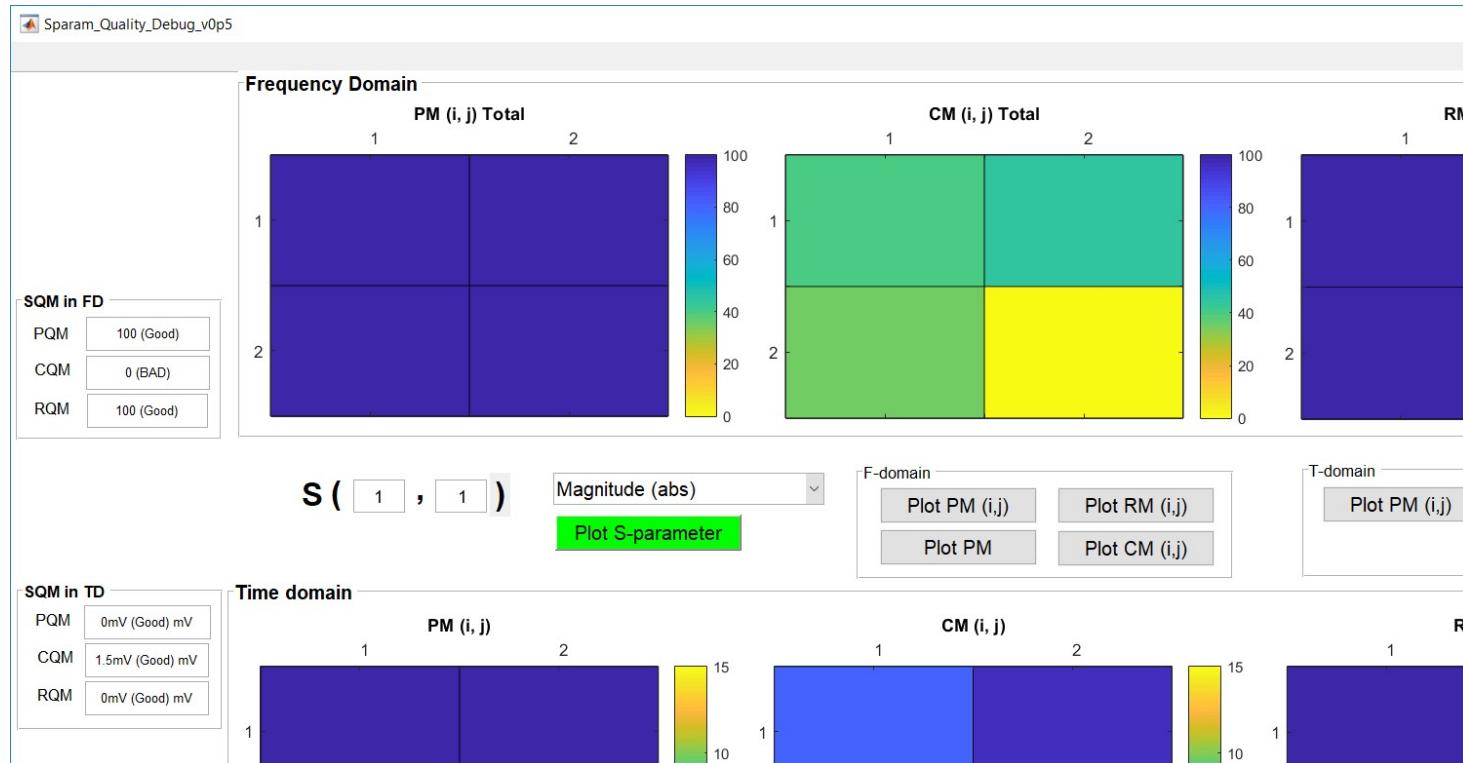
SQM in TD

- Passivity Quality in TD



## De-embedding Verification

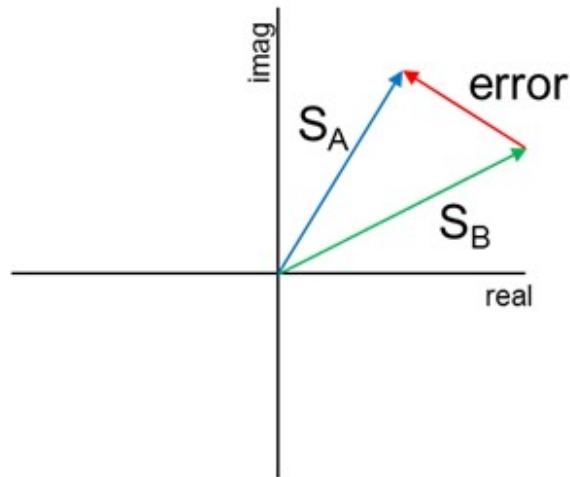
- Plug and Play Fixture example: 50 Ohm microstrip, 45 Ohm fixture, uncorr.





## Comparison of S-parameters

- Method needed for comparison besides “eyeball the plot”
  - Feature Selective Verification (FSV) – not recommended
  - Recommend Error Vector method



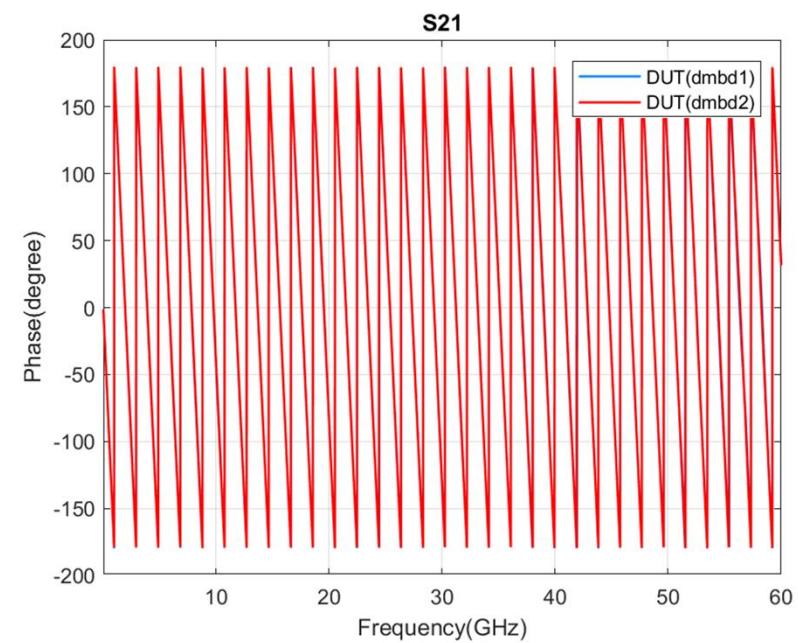
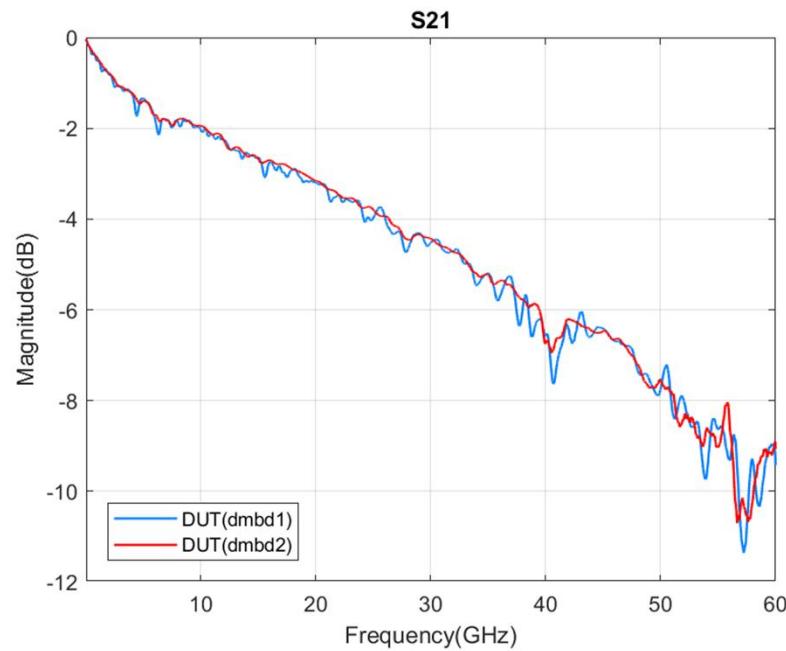
$$EF_{ij}(f) = \text{mag} [S_{ij}^A(f) - S_{ij}^B(f)]$$

$$rEF_{ij} = \frac{\text{mag}[EF_{ij}(f)]}{0.5 \times \text{mag}[S_{ij}^A(f) + S_{ij}^B(f)]}$$



## S-parameter Comparison

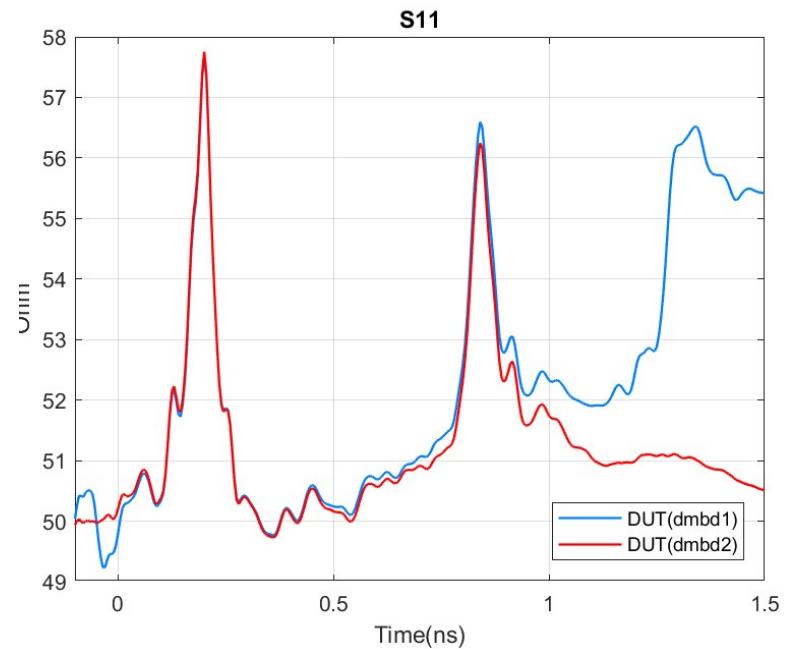
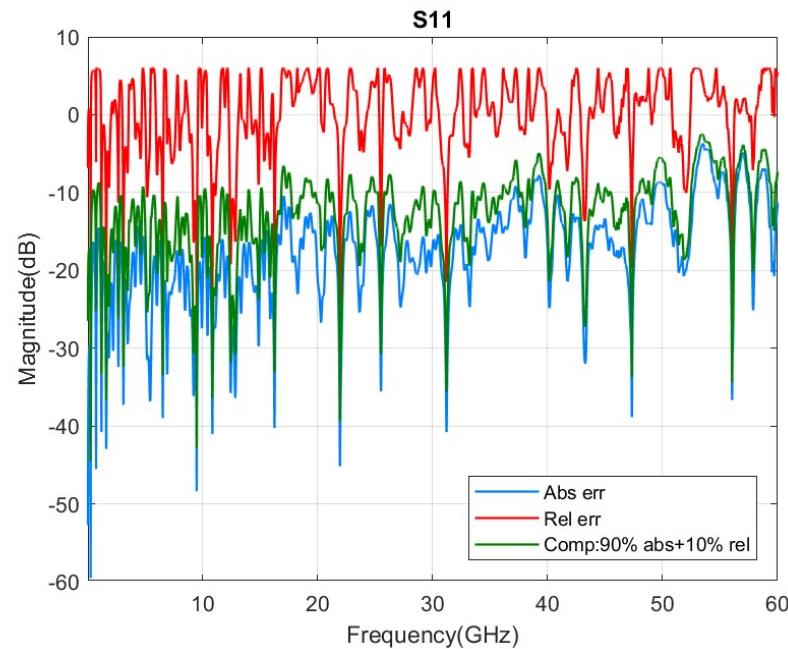
- Plug and Play Fixture example: 50 Ohm microstrip, 50/45 Ohm fixture, Z corr.





## S-parameter Comparison

- Plug and Play Fixture example: 50 Ohm microstrip, 50/45 Ohm fixture, Z corr.





## More Information

See <https://standards.ieee.org/develop/project/370.html>

## Acknowledgements

Eric Bogatin (Teledyne LeCroy), Heidi Barnes (Keysight), Hansel Dsilva (Intel), Clement Luc (Hirose), Se-Jung Moon (Intel), Jose Moreira (Advantest), Jim Nadolny (Samtec),

## References

1. Barnes, H., Bogatin, E., Moreira, J., Ellison, J., Nadolny, J., Huang, C.-C., Tsiklauri, M., Moon, S.-J., and Herrmann, V.: "A NIST Traceable PCB KIT for Evaluating the Accuracy of De-Embedding Algorithms and Corresponding Metrics", DesignCon 2018.
2. Y. Shlepnev, Quality Metrics for S-parameter Models, presentation at DesignCon 2010 IBIS Summit, Santa Clara, February 4, 2010.